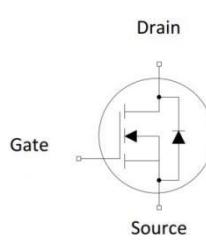


N-channel 700V, 15A, 0.28Ω Super-Junction Power MOSFET

Description	Product Summary
<p>Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFET , designed according to the SJ principle. The resulting device has extremely low on resistance,making it especially suitable for applications which require superior power density and outstanding efficiency.</p>	<p>$V_{DS} @ T_{j,25^\circ C}$ 700V $R_{DS(on),max}$ 0.28Ω I_D 15A $Q_{g,typ}$ 26 nC</p>
	
Features	TO-252 TO-251 TO-220F
<ul style="list-style-type: none"> ◆ Very low FOM $R_{DS(on)} \times Q_g$ ◆ 100% UIS tested ◆ RoHS compliant 	
Applications	
<ul style="list-style-type: none"> ◆ Power factor correction (PFC). ◆ Switched mode power supplies (SMPS). ◆ Uninterrupted power supply (UPS). 	N-Channel MOSFET

Marking information

Product	Package	Marking	Packing method
RMA70R280SN	TO-252	RMA70R280SN	Reel
RMG70R280SN	TO-251	RMG70R280SN	Tube
RMC70R280SN	TO-220F	RMC70R280SN	Tube

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	700	V
Continuous drain current ($T_c = 25^\circ C$) ($T_c = 100^\circ C$)	I_D	15	A
		9	A
Pulsed drain current ¹⁾	I_{DM}	45	A
Gate-Source voltage	V_{GSS}	± 30	V
Avalanche energy, single pulse ²⁾	E_{AS}	320	mJ
Avalanche current, repetitive ³⁾	I_{AR}	2.2	A
Power Dissipation TO-252 / TO-251 ($T_c = 25^\circ C$) - Derate above $25^\circ C$	P_D	132	W
		1.06	W/ $^\circ C$
Power Dissipation TO-220F ($T_c = 25^\circ C$) - Derate above $25^\circ C$	P_D	34	W
		0.27	W/ $^\circ C$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ C$
Continuous diode forward current	I_S	15	A
Diode pulse current	$I_{S,pulse}$	45	A

Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO252/TO-251	TO-220F	
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.93	3.4	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	106	58	°C/W
Soldering temperature, wave soldering only allowed at leads. (1.6mm from case for 10s)	T_{sold}	260	260	°C

Electrical Characteristics

 $T_c = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0 \text{ V}, I_{\text{D}}=250 \mu\text{A}$	700	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250 \mu\text{A}$	2.5		4.0	V
Drain cut-off current	I_{DSS}	$V_{\text{DS}}=700 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	-	-	1	μA
Gate leakage current, Forward	I_{GSSF}	$V_{\text{GS}}=30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	100	nA
Gate leakage current, Reverse	I_{GSSR}	$V_{\text{GS}}=-30 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10 \text{ V}, I_{\text{D}}=7.5 \text{ A}$ $T_j = 25^\circ\text{C}$	-	0.24	0.28	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}} = 100 \text{ V}, V_{\text{GS}} = 0 \text{ V},$ $f = 1 \text{ MHz}$	-	1126	-	pF
Output capacitance	C_{oss}		-	41	-	
Reverse transfer capacitance	C_{rss}		-	2.4	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 400 \text{ V}, I_{\text{D}} = 7.5 \text{ A}$ $R_G = 25 \Omega, V_{\text{GS}}=10 \text{ V}$	-	20	-	ns
Rise time	t_r		-	40	-	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	95	-	
Fall time	t_f		-	43	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{\text{DD}}=560 \text{ V}, I_{\text{D}}=7.5 \text{ A},$ $V_{\text{GS}}=0 \text{ to } 10 \text{ V}$	-	3.6	-	nC
Gate to drain charge	Q_{gd}		-	10.5	-	
Gate charge total	Q_g		-	26	-	
Gate plateau voltage	V_{plateau}		-	5.5	-	
Reverse diode characteristics						
Diode forward voltage	V_{SD}	$V_{\text{GS}}=0 \text{ V}, I_{\text{F}}=7.5 \text{ A}$	-	0.85	-	V
Reverse recovery time	t_{rr}	$V_R=400 \text{ V}, I_{\text{F}}=7.5 \text{ A},$ $dI_{\text{F}}/dt=100 \text{ A}/\mu\text{s}$	-	405	-	ns
Reverse recovery charge	Q_{rr}		-	4.0	-	μC
Peak reverse recovery current	I_{rrm}		-	21	-	A

Notes:

1. Limited by maximum junction temperature, maximum duty cycle is 0.75.

2. $I_{\text{AS}} = 4 \text{ A}, V_{\text{DD}} = 50 \text{ V}$, Starting $T_j = 25^\circ\text{C}$.

Electrical Characteristics Diagrams

Figure 1. Output Characteristics

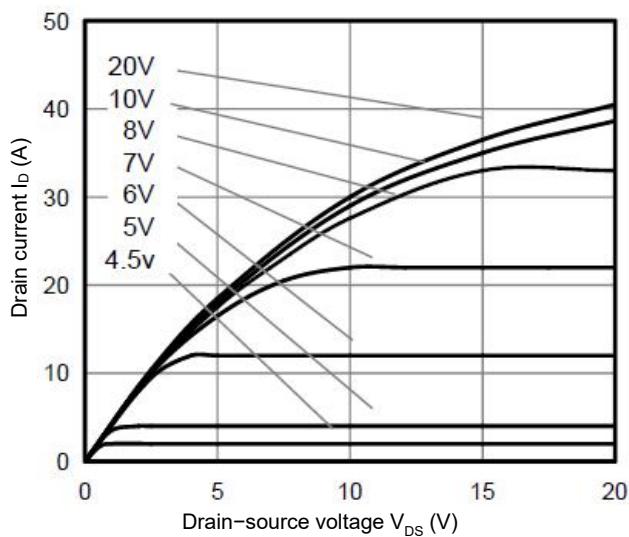


Figure 3. On-Resistance vs. Drain Current

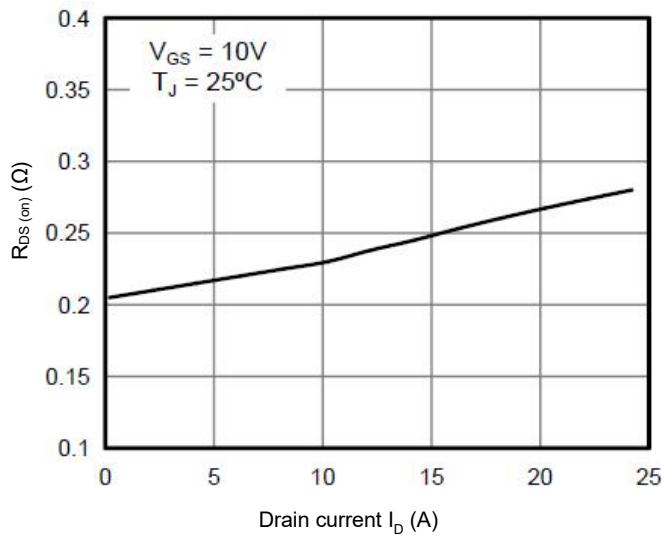


Figure 5. Gate Charge Characteristics

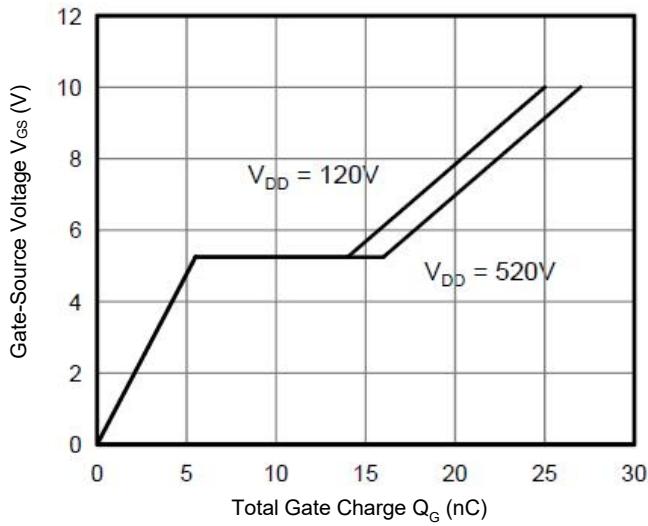


Figure 2. Transfer Characteristics

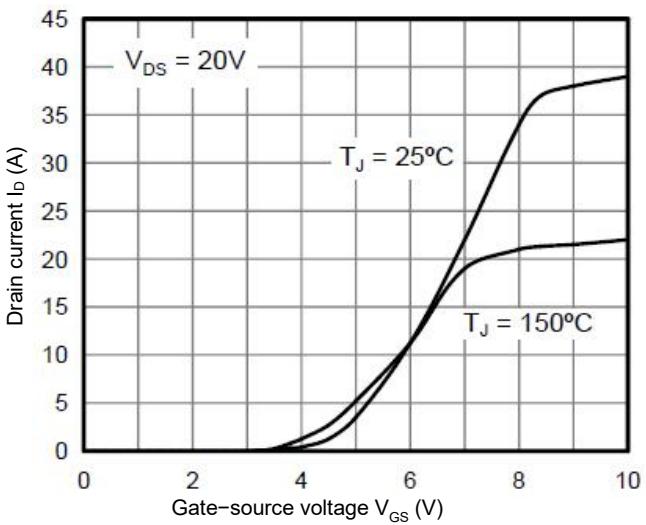


Figure 4. Capacitance Characteristics

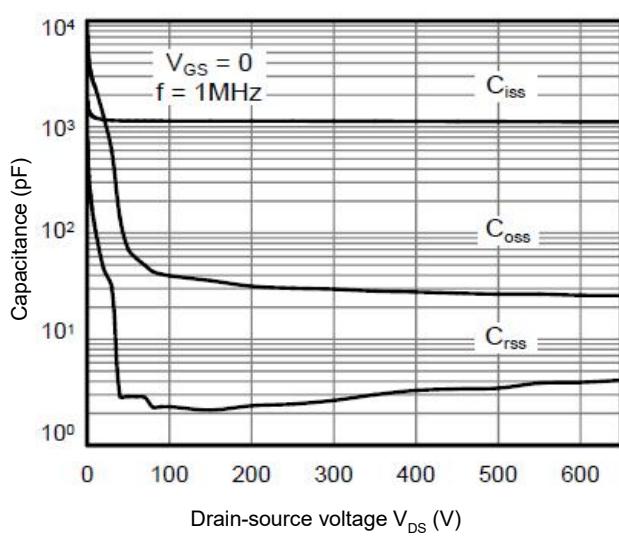


Figure 6. Body Diode Forward Voltage

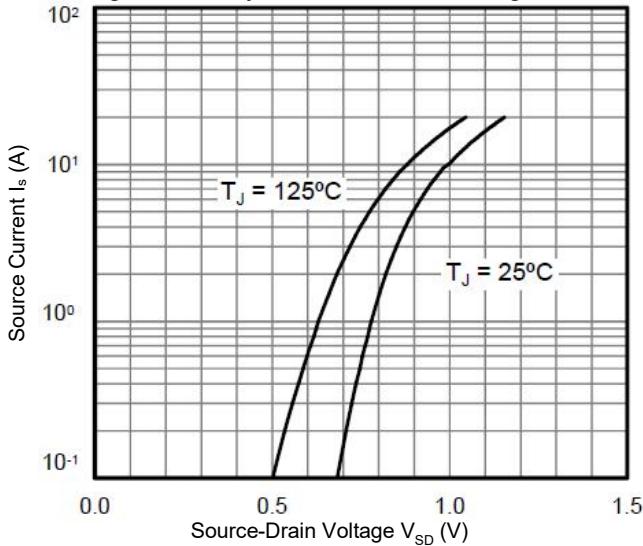


Figure 7. Breakdown Voltage vs. Temperature

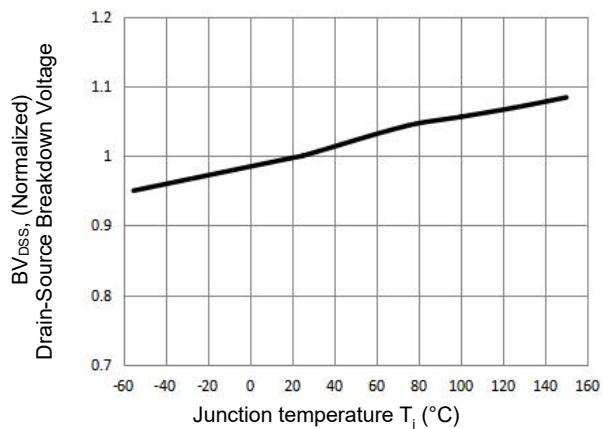
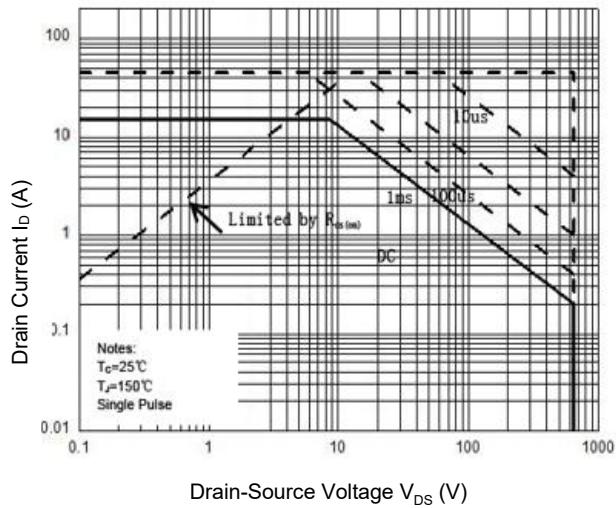


Figure 9. Maximum Safe Operating Area
TO-252/TO-251



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Figure 8. On-Resistance vs. Temperature

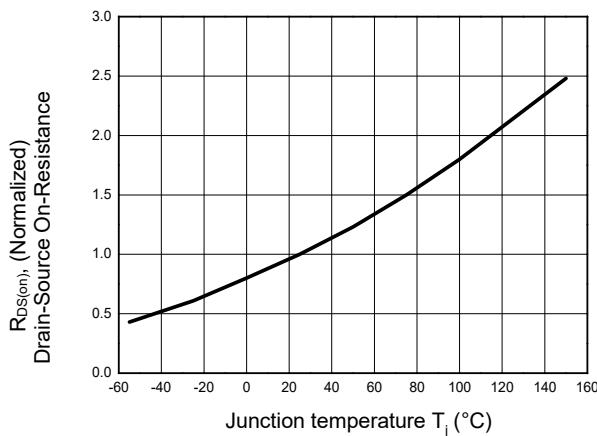
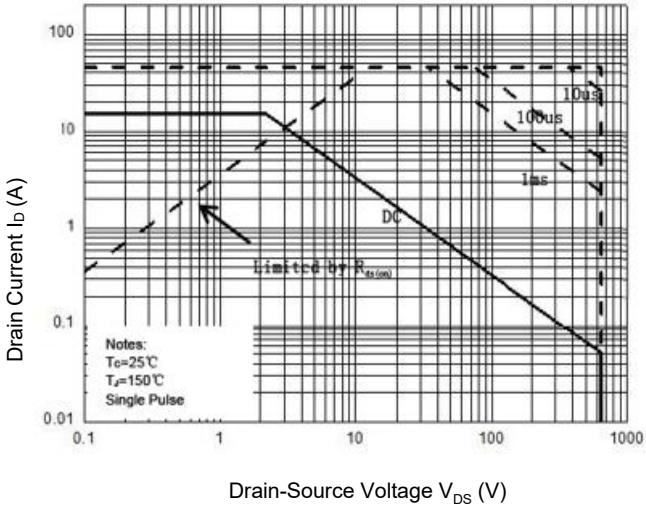
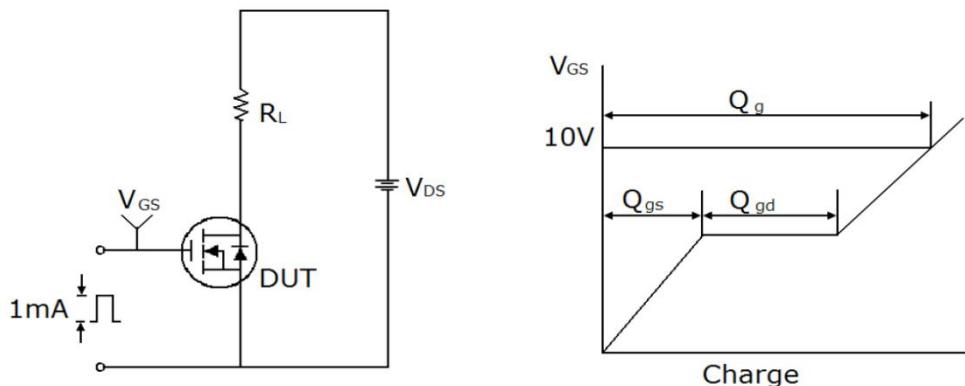


Figure 10. Maximum Safe Operating Area
TO-220F

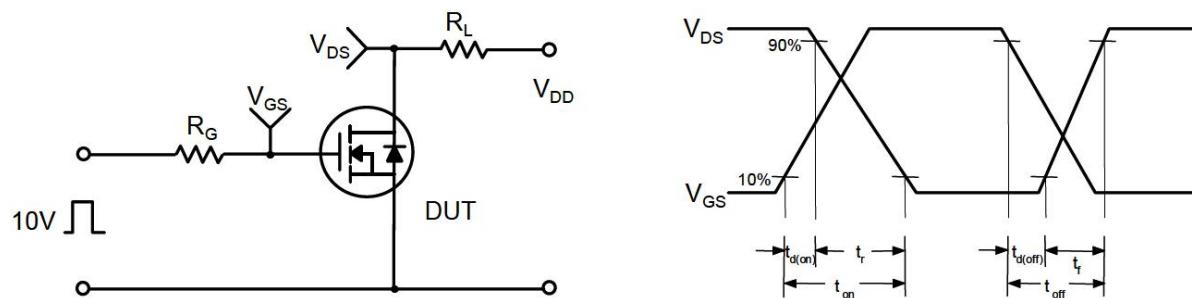


Test Circuits

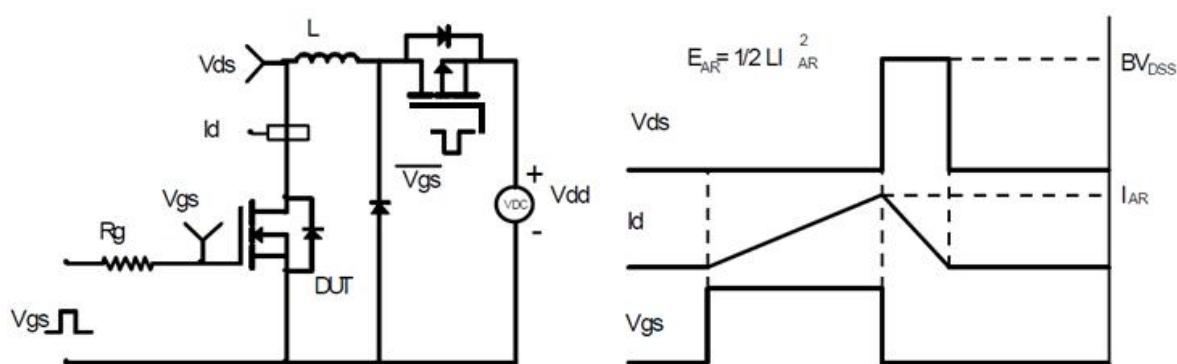
Gate Charge Test Circuit & Waveform

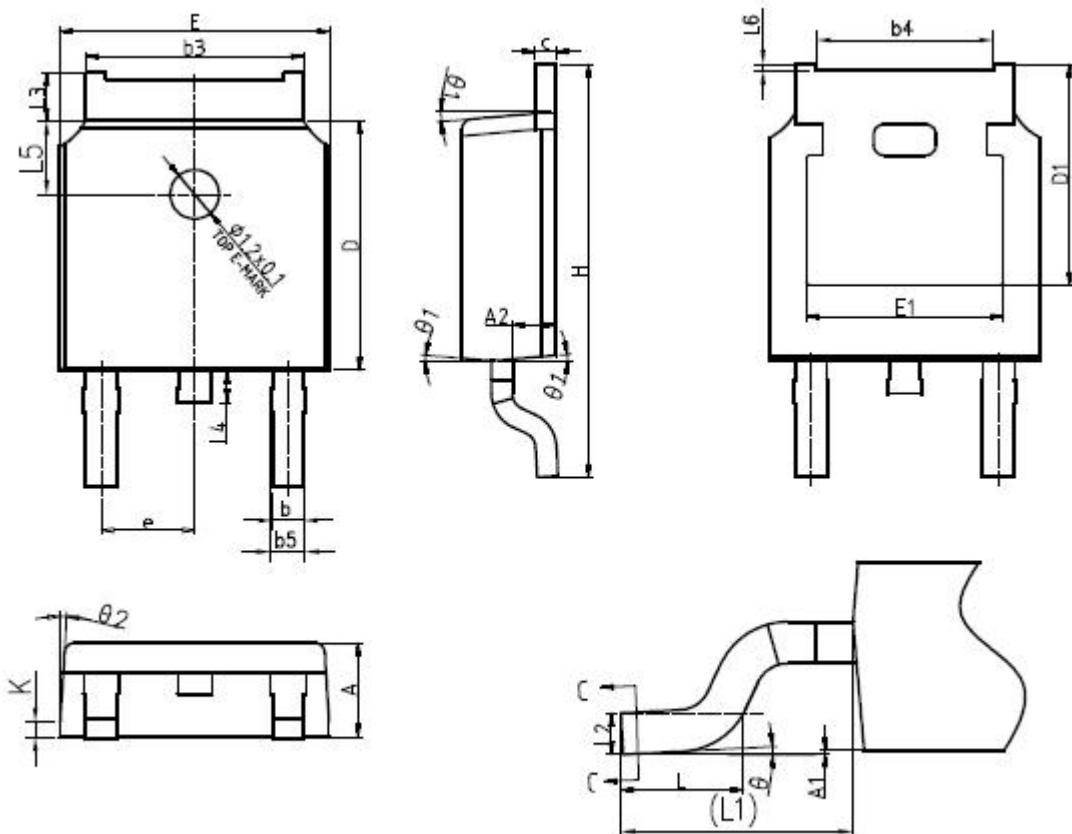


Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

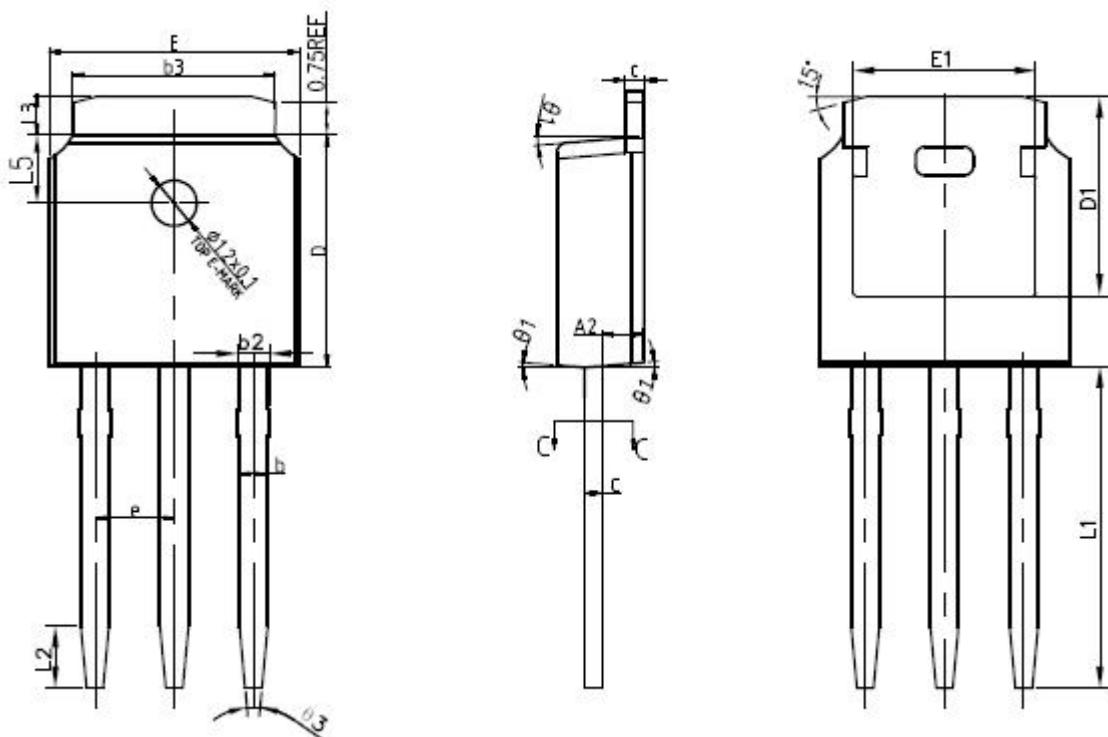


Mechanical Dimensions for TO-252


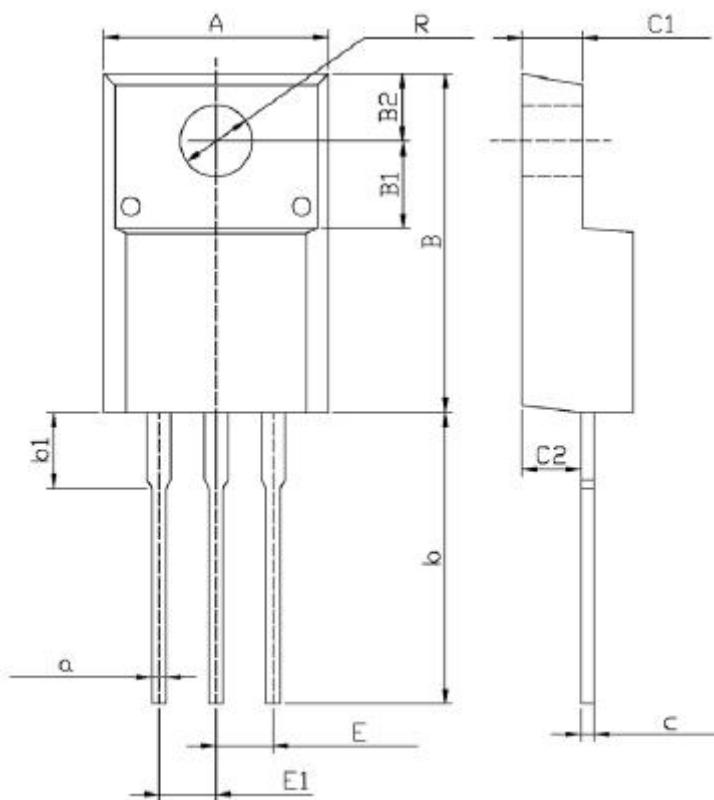
单位: mm

SYMBOL	mm		
	MIN	NOM	MAX
*A	2.20	2.30	2.38
*A1	0.00	-	0.10
A2	0.97	1.07	1.17
*b	0.72	0.78	0.85
b1	0.71	0.76	0.81
*b3	5.23	5.33	5.46
b4	4.27	4.32	4.37
b5	0.72	0.88	0.93
*c	0.47	0.53	0.58
c1	0.46	0.51	0.56
*D	6.00	6.10	6.20
D1		5.30REF	

*E	6.50	6.60	6.70
E1	4.70	4.83	4.92
*e	2.286BSC		
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.51BSC		
*L3	0.90	-	1.25
*L4	0.60	0.80	1.00
L5	1.70	1.80	1.90
L6	0	0.047	0.123
θ	0°	-	8°
*θ1	5°	7°	9°
θ2	5°	7°	9°
K	0.40REF		

Mechanical Dimensions for TO-251


SYMBOL	MM		
	MIN	NOM	MAX
*A	2.20	2.30	2.38
*A2	0.97	1.07	1.17
*b	0.72	0.78	0.85
b1	0.71	0.76	0.81
*b2	0.72	0.88	0.95
*b3	5.23	5.33	5.46
*c	0.47	0.53	0.58
c1	0.46	0.51	0.56
*D	6.00	6.10	6.20
D1	5.30REF		
*E	6.50	6.60	6.70
E1	4.70	4.83	4.92
*e	2.286BSC		
*L1	9.20	9.40	9.60
L2	1.25	1.35	1.45
*L3	0.90	1.02	1.25
L5	1.70	1.80	1.90
*θ1	5°	7°	9°
θ2	5°	7°	9°
θ3	11°	13°	15°
K	0.40REF		

Mechanical Dimensions for TO-220F


Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
C	4.3	4.7	b1	2.9	3.9
A	9.7	10.3	α	0.55	0.75
B	14.7	15.3	E	2.29	2.79
B1	3.8	4.0	E1	2.29	2.79
B2	2.9	3.1	C1	2.5	2.9
R	3.0	3.4	C2	2.5	2.7
b	12.5	13.5	c	0.5	0.7

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